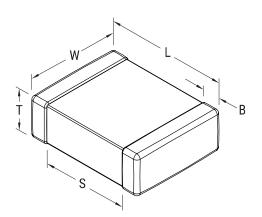
## KEMET Part Number: C0603C103K3RECTU

(C0603C103K3REC7867)



ESD SMD Comm X7R, Ceramic, 0.01 uF, 10%, 25 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 0603



Dimensions		
Chip Size	0603	
L	1.6mm +/-0.15mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.07mm	
S	0.7mm MIN	
В	0.35mm +/-0.15mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Paper Tape	
Packaging Quantity:	4000	

General Information		
Series:	ESD SMD Comm X7R	
Style:	SMD Chip	
Description:	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II	
Features:	Temperature Stable, Class II	
RoHS:	Yes	
Termination:	Tin	
Marking:	No	
AEC-Q200:	No	
Component Weight:	4800 ug	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications	
Capacitance:	0.01 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	10%
Voltage DC:	25 VDC
ESD Level per AEC-Q200:	25,000 V ESD Level
Dielectric Withstanding Voltage:	62.5 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms
Dissipation Factor:	3.5% 1 kHz 1.0Vrms
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	100 GOhms

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